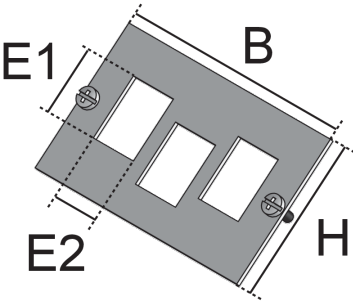


UDEP RMSC 3

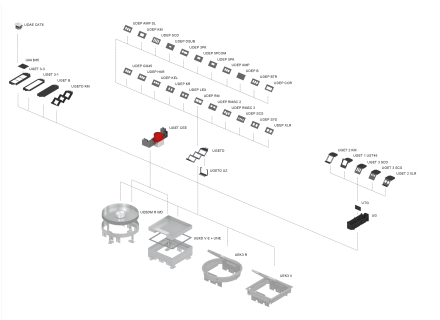
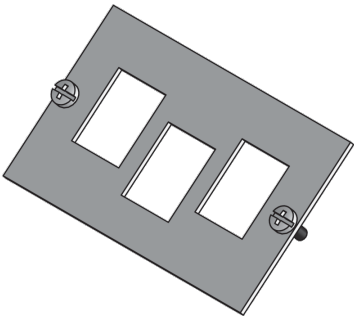
Mounting board, data technology



UDEP RMSC 3 components are installation boards from the underfloor system range. The boards are bolted into data device carriers and are used to accommodate up to 3 snap-in data jacks made by R&M. The installation boards are made of aluminium with a black coating on one side and have the installation dimensions of E1 19.5 mm and E2 14.9 mm.

Artikel	Typ	H	B	data jacks	E1	E2	colour	W
UDEP-RMSC 3	adapter board,	46 mm	75 mm	3	19.5 mm	14.9 mm	black	0.014 kg

DETAIL- UND ANWENDUNGSBILDER



OPTIONALES ZUBEHÖR

UGETD

